

**Annex 2:**  
**European Higher Education Fair 2019 Japan (EHEF 2019)**  
**Exhibitor Application Form**

**The registration deadline is 31<sup>th</sup> JANUARY 2019.**

*(invoice will be sent by Campus France after submission of application form)*

**To register please complete SIGN, STAMP and E-MAIL your completed application form to:**  
[bun-tieng.ung@campusfrance.org](mailto:bun-tieng.ung@campusfrance.org)

<b>Contact Person</b> <i>(all EHEF-related correspondence will be sent to this person)</i>			
<b>Institution Name</b>		<b>Country</b>	
<b>Institution Address</b>			
<b>Telephone</b>			
<b>E-mail</b>			
<b>Website</b>			

► **I would like to book a booth at the EHEF 2019:**

FAIR	FEE
<input type="checkbox"/> TOKYO fair (19 May), OSAKA fair (18 May)	EUR 900
<input type="checkbox"/> TOKYO fair only (19 May)	EUR 800
<input type="checkbox"/> Option assistant linguistique (TOKYO & OSAKA)	EUR 200
<input type="checkbox"/> Option assistant linguistique (TOKYO only)	EUR 100

Participation in 20 May Networking Event (Tokyo)      YES       NO

Participation in 20 May Welcome Reception (Tokyo)      YES       NO

- **Booth staff (Max. 4 per institution)** *Please note there will only be space for two staff to be behind the booth at any one time.*

Name	Position	E-mail
1.		
2.		
3.		
4.		

Date, Stamp, and signature of the institution:

By submitting this application, the institution agrees to the EHEF 2018 *Terms and Conditions* (Annex 1)